### 1A SBR<sup>®</sup> SUPER BARRIER RECTIFIER

#### **Features**

- Low Forward Voltage Drop
- Low Reverse Leakage
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, fast switching capability
- 150°C Operating Junction Temperature
- Lead Free/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

#### **Mechanical Data**

- Case: SOD123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Leads: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating) Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: 0.004 grams (approximate)

Top View

### Ordering Information (Note 3)

Part Number	Case	Packaging
SBR1A40S1-7	SOD123	3000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**



 $\underline{D}$   $\underline{4}$  = Product Type Marking Code  $\overline{YM}$  = Date Code Marking Y = Year (ex: X = 2010)

M = Month (ex: 9 = September)

Date Code Key

Year	201	0	2011		2012	20	13	2014		2015	2	2016
Code	X		Υ		Z	, ,	4	В		С		D
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

# **Maximum Ratings** $@T_A = 25$ <sup> $\circ$ </sup>C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>RM</sub>	40	V
Average Rectified Output Current T <sub>C</sub> = 65℃	Io	1	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	20	A

# **Thermal Characteristics**

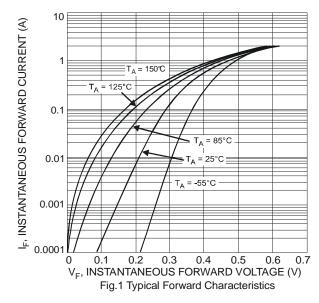
Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Thermal Resistance Junction to Ambient (Note 4) Thermal Resistance Junction to Ambient (Note 5)	R <sub>0</sub> JA R <sub>0</sub> JA	473 407	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C
Power Dissipation (Note 7)	PD R <sub>θ</sub> JC	320 147	mW °C/W

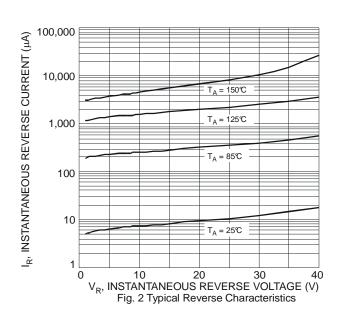
# Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	\ <i>/</i>	-	-	0.52	· V	I <sub>F</sub> = 1A, T <sub>J</sub> = 25°C
Polward voltage blop	V <sub>F</sub>	-	0.44	0.50		I <sub>F</sub> = 1A, T <sub>J</sub> = 125°C
Lookaga Current (Note C)	I <sub>R</sub>	-	18	200	μΑ	$V_R = 40V, T_J = 25^{\circ}C$
Leakage Current (Note 6)		-	4	-	mA	$V_R = 40V, T_J = 100^{\circ}C$

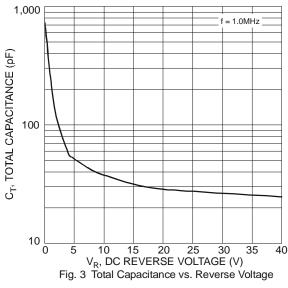
Notes:

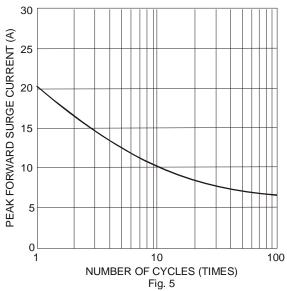
- 4. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
- 5. Polymide PCB, 2 oz. Copper, minimum recommended pad layout pad layout per http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.
  7. Device mounted on FR-4 substate,1"\*1",2oz, copper,singie-sided,PC boards.

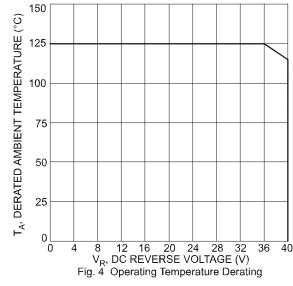


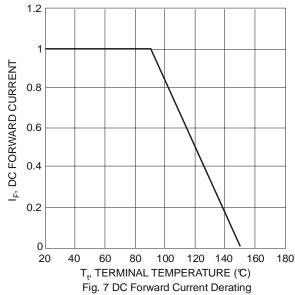


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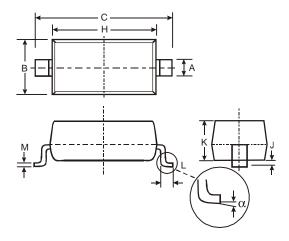






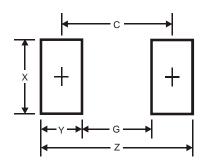


# Package Outline Dimensions



SOD123					
Dim	Min	Max			
Α	0.55 Typ				
В	1.40	1.70			
С	3.55	3.85			
Н	2.55	2.85			
J	0.00	0.10			
K	1.00	1.35			
L	0.25	0.40			
M	0.10	0.15			
α	0	8°			
All Dimensions in mm					

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	4.9
G	2.5
Х	0.7
Y	1.2
С	3.7

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  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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